

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2792492

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUNG-BUM JANG	01/08/2014
BYEONG-HWA KIM	01/08/2014
HONG-PYO LEE	01/08/2014
RECEIVING PARTY DATA	
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City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	135-791
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14348455
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NAME OF SUBMITTER:	HOSANG LEE
SIGNATURE:	/Hosang Lee/
DATE SIGNED:	03/31/2014
Total Attachments: 1	
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(SAB)

Docket No.: _____

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) Jung-Bum JANG
- (2) Byeong-Hwa KIM
- (3) Hong-Pyo LEE

who have made a certain new and useful invention, hereby sell, assign and transfer unto

KOREA ELECTRIC POWER CORPORATION

#512, Yeongdong-daero Gangnam-gu, Seoul 135-791, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled **METHOD FOR EVALUATING PRESTRESSING FORCE OF BONDED TENDON USING VELOCITY OF STRESS WAVES CAUSED BY IMPACT**

(a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or

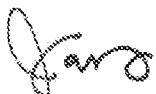
(b) for which an application for United States Letters Patent was executed on _____, and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;


AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

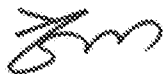
SIGNED on the dates indicated aside our signatures:

INVENTOR(S)

DATE SIGNED

1)  Jan. 08, 2014
 Name: Jung-Bum JANG

2)  Jan. 08, 2014
 Name: Byeong-Hwa KIM

3)  Jan. 08, 2014
 Name: Hong-Pyo LEE

PATENT